

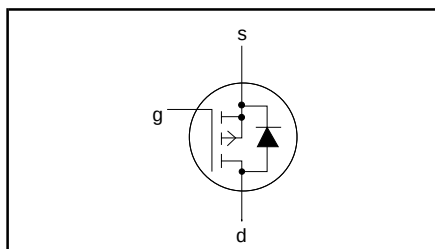
## P-channel enhancement mode MOS transistor

BSH205

### FEATURES

- Very low threshold voltage
- Fast switching
- Logic level compatible
- Subminiature surface mount package

### SYMBOL



### QUICK REFERENCE DATA

|                                                         |
|---------------------------------------------------------|
| $V_{DS} = -12\text{ V}$                                 |
| $I_D = -0.75\text{ A}$                                  |
| $R_{DS(ON)} \leq 0.5\ \Omega\ (V_{GS} = -2.5\text{ V})$ |
| $V_{GS(TO)} \geq 0.4\text{ V}$                          |

### GENERAL DESCRIPTION

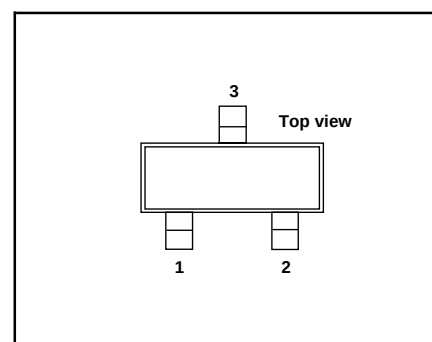
P-channel, enhancement mode, logic level, field-effect power transistor. This device has low threshold voltage and extremely fast switching making it ideal for battery powered applications and high speed digital interfacing.

The BSH205 is supplied in the SOT23 subminiature surface mounting package.

### PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | gate        |
| 2   | source      |
| 3   | drain       |

### SOT23



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL         | PARAMETER                        | CONDITIONS                        | MIN. | MAX.    | UNIT             |
|----------------|----------------------------------|-----------------------------------|------|---------|------------------|
| $V_{DS}$       | Drain-source voltage             |                                   | -    | -12     | V                |
| $V_{DGR}$      | Drain-gate voltage               |                                   | -    | -12     | V                |
| $V_{GS}$       | Gate-source voltage              |                                   | -    | $\pm 8$ | V                |
| $I_D$          | Drain current (DC)               | $R_{GS} = 20\text{ k}\Omega$      | -    | -0.75   | A                |
| $I_{DM}$       | Drain current (pulse peak value) | $T_a = 25\text{ }^\circ\text{C}$  | -    | -0.47   | A                |
| $P_{tot}$      | Total power dissipation          | $T_a = 100\text{ }^\circ\text{C}$ | -    | -3      | A                |
| $T_{stg}, T_j$ | Storage & operating temperature  | $T_a = 25\text{ }^\circ\text{C}$  | -    | 0.417   | W                |
|                |                                  | $T_a = 100\text{ }^\circ\text{C}$ | -    | 0.17    | W                |
|                |                                  |                                   | - 55 | 150     | $^\circ\text{C}$ |

### THERMAL RESISTANCES

| SYMBOL             | PARAMETER                              | CONDITIONS                   | TYP. | MAX. | UNIT |
|--------------------|----------------------------------------|------------------------------|------|------|------|
| $R_{th\text{-}ja}$ | Thermal resistance junction to ambient | FR4 board, minimum footprint | 300  | -    | K/W  |

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BSH205

## ELECTRICAL CHARACTERISTICS

 $T_j = 25^\circ\text{C}$  unless otherwise specified

| SYMBOL        | PARAMETER                        | CONDITIONS                                                              | MIN. | TYP.     | MAX.      | UNIT          |
|---------------|----------------------------------|-------------------------------------------------------------------------|------|----------|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage   | $V_{GS} = 0\text{ V}; I_D = -10\text{ }\mu\text{A}$                     | -12  | -        | -         | V             |
| $V_{GS(TO)}$  | Gate threshold voltage           | $V_{DS} = V_{GS}; I_D = -1\text{ mA}$                                   | -0.4 | -0.68    | -         | V             |
|               |                                  | $T_j = 150^\circ\text{C}$                                               | -0.1 | -        | -         | V             |
| $R_{DS(ON)}$  | Drain-source on-state resistance | $V_{GS} = -4.5\text{ V}; I_D = -430\text{ mA}$                          | -    | 0.18     | 0.4       | $\Omega$      |
|               |                                  | $V_{GS} = -2.5\text{ V}; I_D = -430\text{ mA}$                          | -    | 0.32     | 0.5       | $\Omega$      |
|               |                                  | $V_{GS} = -1.8\text{ V}; I_D = -210\text{ mA}$                          | -    | 0.42     | 0.6       | $\Omega$      |
|               |                                  | $V_{GS} = -2.5\text{ V}; I_D = -430\text{ mA}; T_j = 150^\circ\text{C}$ | -    | 0.48     | 0.75      | $\Omega$      |
| $g_{fs}$      | Forward transconductance         | $V_{DS} = -9.6\text{ V}; I_D = -430\text{ mA}$                          | 0.5  | 1.6      | -         | S             |
| $I_{GSS}$     | Gate source leakage current      | $V_{GS} = \pm 8\text{ V}; V_{DS} = 0\text{ V}$                          | -    | $\pm 10$ | $\pm 100$ | nA            |
| $I_{DSS}$     | Zero gate voltage drain current  | $V_{DS} = -9.6\text{ V}; V_{GS} = 0\text{ V}; T_j = 150^\circ\text{C}$  | -    | -50      | -100      | nA            |
|               |                                  |                                                                         | -    | -11      | -100      | $\mu\text{A}$ |
| $Q_{g(tot)}$  | Total gate charge                | $I_D = -0.5\text{ A}; V_{DD} = -10\text{ V}; V_{GS} = -4.5\text{ V}$    | -    | 3.8      | -         | nC            |
| $Q_{gs}$      | Gate-source charge               |                                                                         | -    | 0.4      | -         | nC            |
| $Q_{gd}$      | Gate-drain (Miller) charge       |                                                                         | -    | 1.0      | -         | nC            |
| $t_{d\ on}$   | Turn-on delay time               | $V_{DD} = -10\text{ V}; I_D = -0.5\text{ A};$                           | -    | 2        | -         | ns            |
| $t_r$         | Turn-on rise time                | $V_{GS} = -8\text{ V}; R_G = 6\text{ }\Omega$                           | -    | 4.5      | -         | ns            |
| $t_{d\ off}$  | Turn-off delay time              | Resistive load                                                          | -    | 45       | -         | ns            |
| $t_f$         | Turn-off fall time               |                                                                         | -    | 20       | -         | ns            |
| $C_{iss}$     | Input capacitance                | $V_{GS} = 0\text{ V}; V_{DS} = -9.6\text{ V}; f = 1\text{ MHz}$         | -    | 200      | -         | pF            |
| $C_{oss}$     | Output capacitance               |                                                                         | -    | 95       | -         | pF            |
| $C_{rss}$     | Feedback capacitance             |                                                                         | -    | 41       | -         | pF            |

## REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

 $T_j = 25^\circ\text{C}$  unless otherwise specified

| SYMBOL    | PARAMETER                        | CONDITIONS                                                  | MIN. | TYP.  | MAX.  | UNIT |
|-----------|----------------------------------|-------------------------------------------------------------|------|-------|-------|------|
| $I_{DR}$  | Continuous reverse drain current | $T_a = 25^\circ\text{C}$                                    | -    | -     | -0.75 | A    |
| $I_{DRM}$ | Pulsed reverse drain current     |                                                             | -    | -     | -3    | A    |
| $V_{SD}$  | Diode forward voltage            | $I_F = -0.38\text{ A}; V_{GS} = 0\text{ V}$                 | -    | -0.72 | -1.3  | V    |
| $t_{rr}$  | Reverse recovery time            | $I_F = -0.5\text{ A}; -dI_F/dt = 100\text{ A}/\mu\text{s};$ | -    | 75    | -     | ns   |
| $Q_{rr}$  | Reverse recovery charge          | $V_{GS} = 0\text{ V}; V_R = -9.6\text{ V}$                  | -    | 69    | -     | nC   |

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BSH205

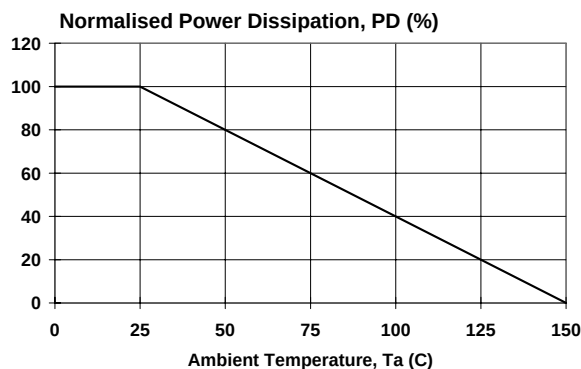


Fig.1. Normalised power dissipation.  
 $PD\% = 100 \cdot P_D / P_{D\ 25^\circ\text{C}} = f(T_a)$

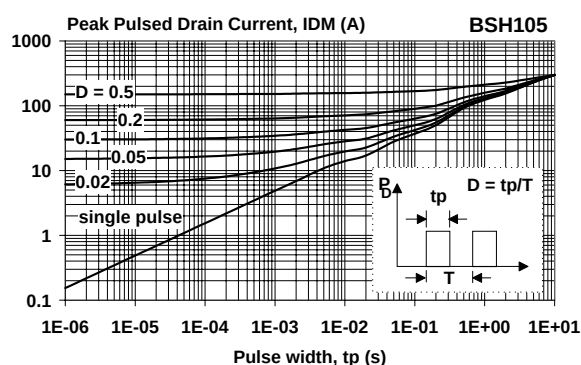


Fig.4. Transient thermal impedance.  
 $Z_{th\ j-a} = f(t)$ ; parameter  $D = t_p/T$

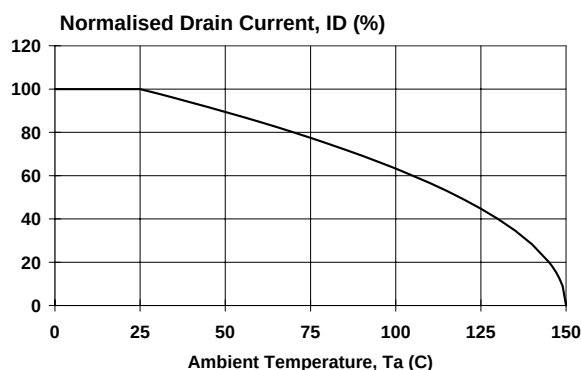


Fig.2. Normalised continuous drain current.  
 $ID\% = 100 \cdot I_D / I_{D\ 25^\circ\text{C}} = f(T_a)$ ; conditions:  $V_{GS} \leq -10\text{ V}$

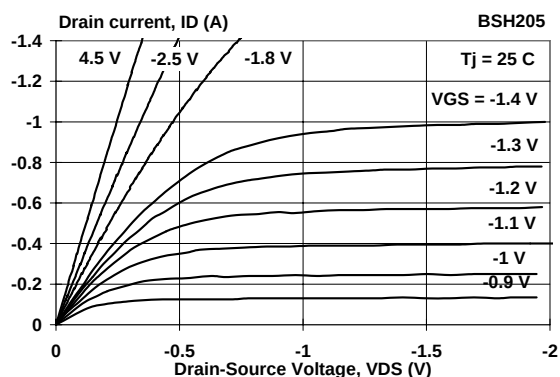


Fig.5. Typical output characteristics,  $T_j = 25^\circ\text{C}$ .  
 $I_D = f(V_{DS})$ ; parameter  $V_{GS}$

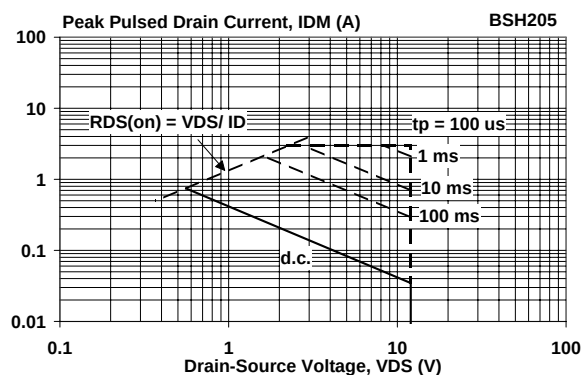


Fig.3. Safe operating area.  $T_a = 25^\circ\text{C}$   
 $I_D$  &  $I_{DM} = f(V_{DS})$ ;  $I_{DM}$  single pulse; parameter  $t_p$

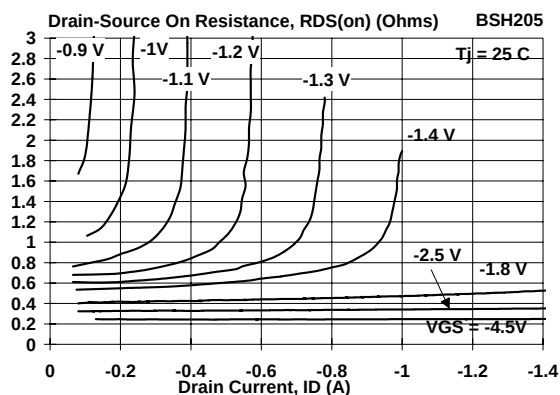
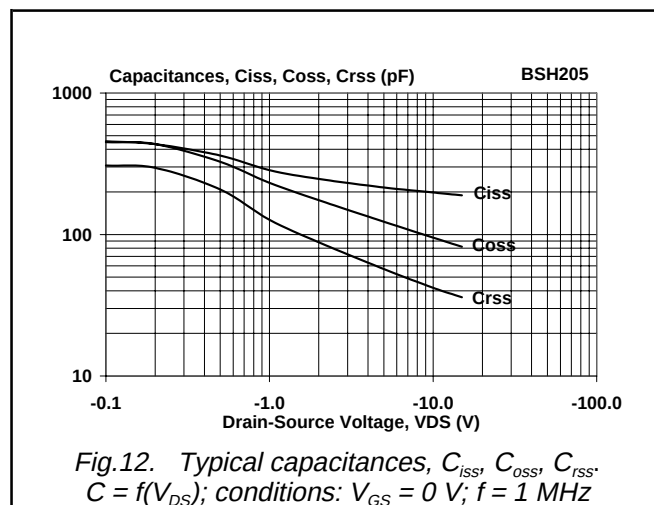
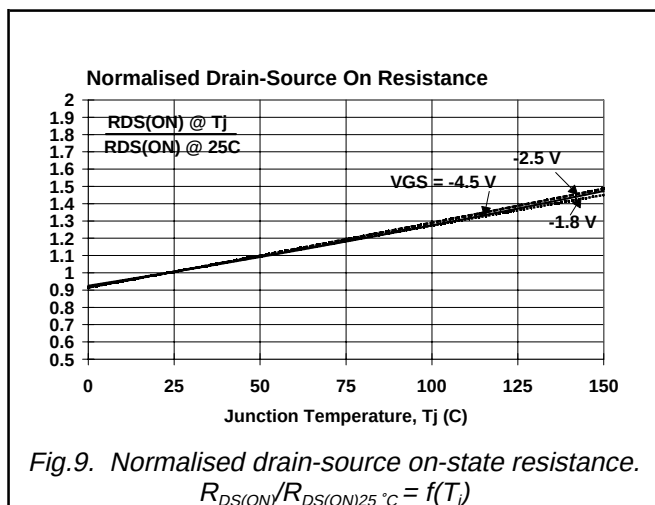
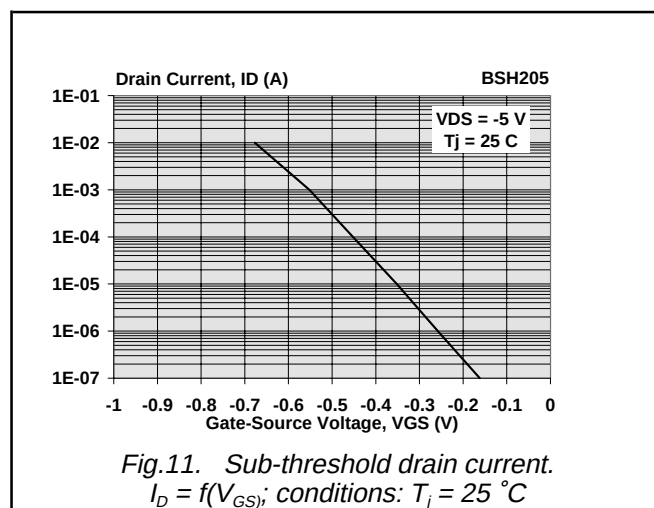
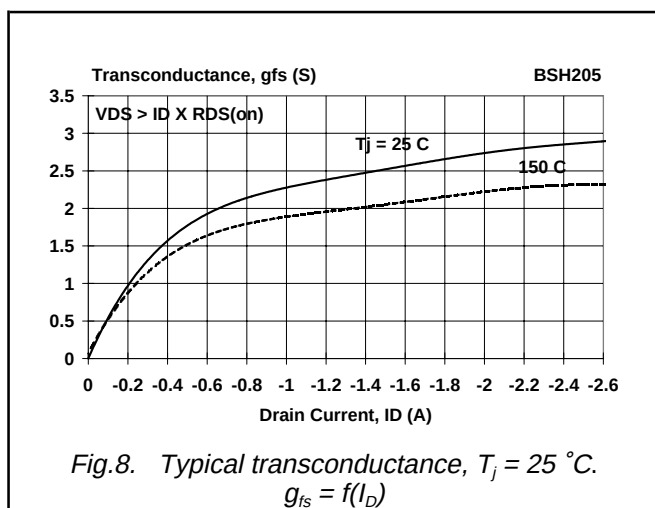
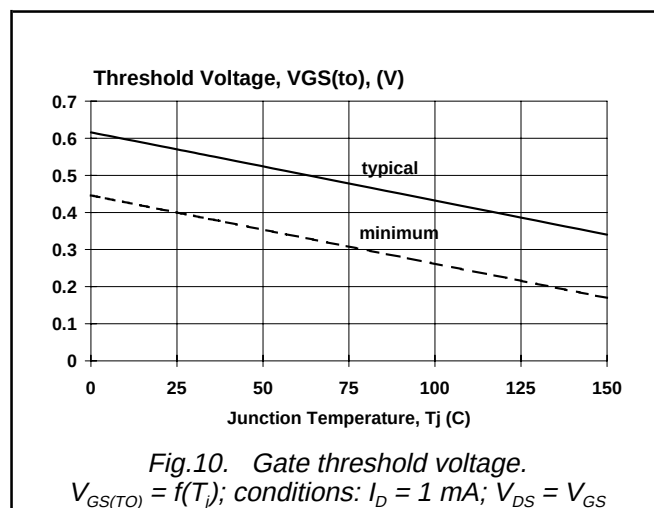
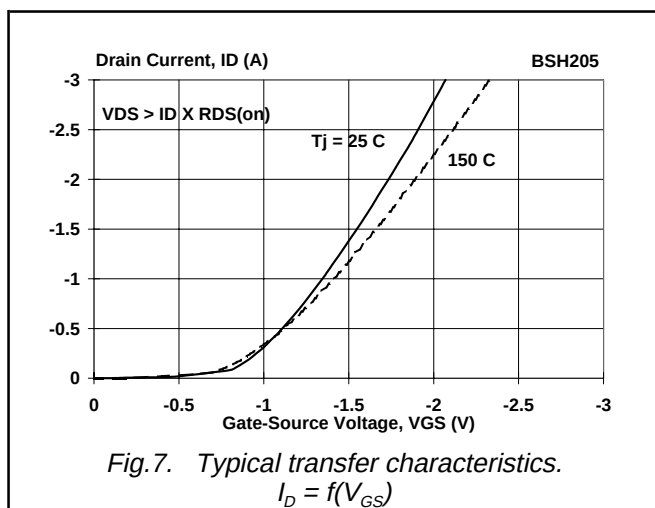


Fig.6. Typical on-state resistance,  $T_j = 25^\circ\text{C}$ .  
 $R_{DS(ON)} = f(I_D)$ ; parameter  $V_{GS}$

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BSH205



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BSH205

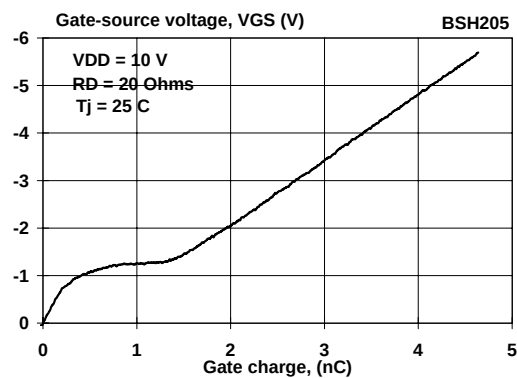


Fig.13. Typical turn-on gate-charge characteristics.  
 $V_{GS} = f(Q_G)$

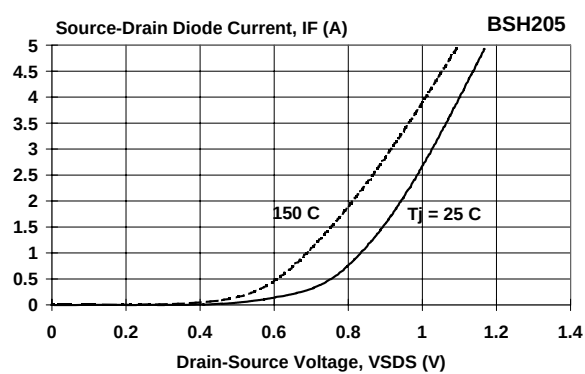
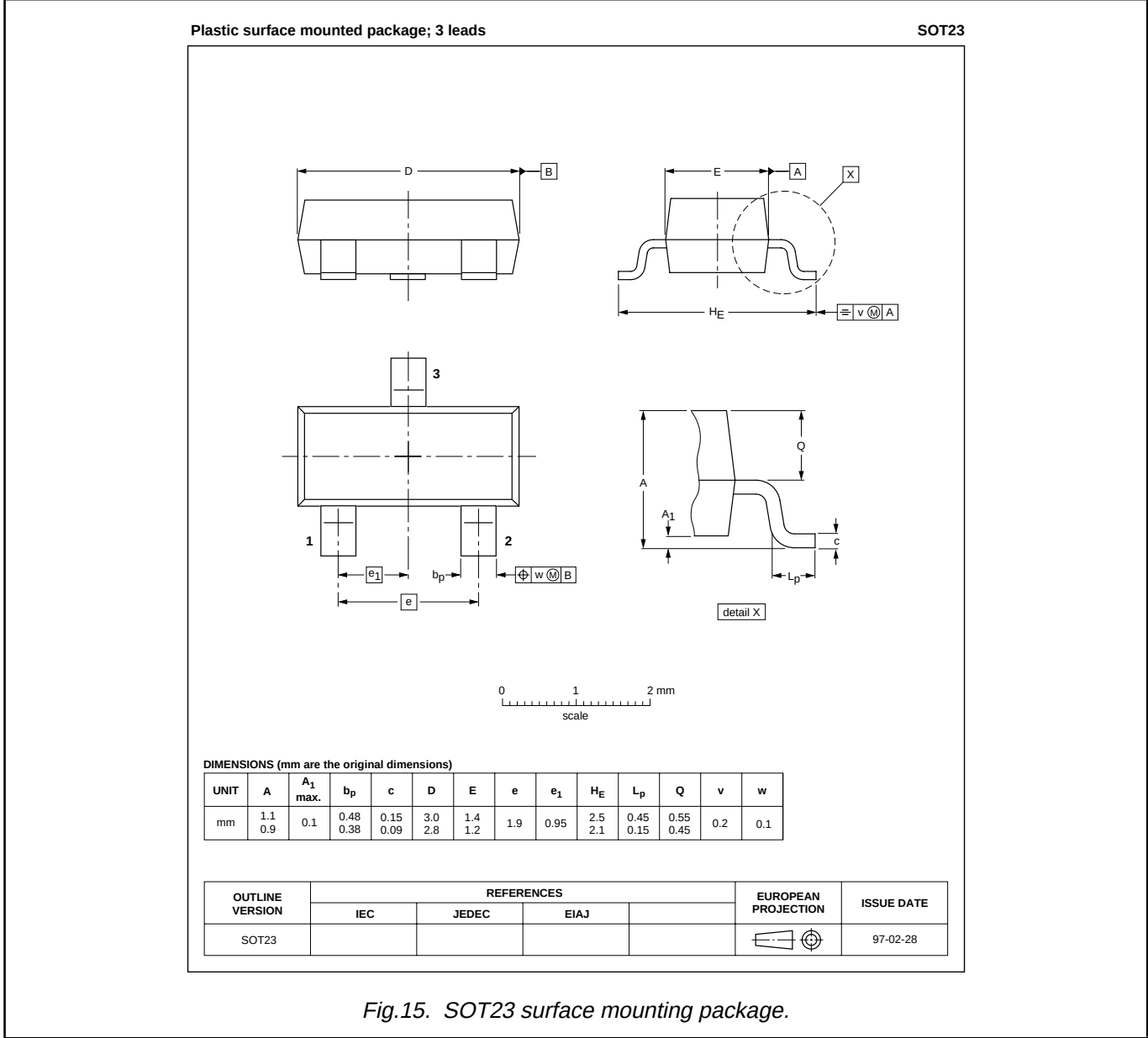


Fig.14. Typical reverse diode current.  
 $I_F = f(V_{SDS})$ ; conditions:  $V_{GS} = 0\text{ V}$ ; parameter  $T_J$

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BSH205

MECHANICAL DATA



Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

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**DEFINITIONS**

| <b>Data sheet status</b>                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                       |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| Objective specification                                                                                                                                                                                                                                                                                                                                                                                                                                    | This data sheet contains target or goal specifications for product development.       |
| Preliminary specification                                                                                                                                                                                                                                                                                                                                                                                                                                  | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification                                                                                                                                                                                                                                                                                                                                                                                                                                      | This data sheet contains final product specifications.                                |
| <b>Limiting values</b>                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                                                       |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                                                                       |
| <b>Application information</b>                                                                                                                                                                                                                                                                                                                                                                                                                             |                                                                                       |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                        |                                                                                       |
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